

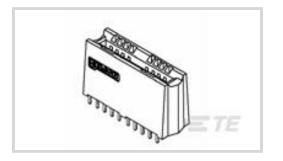
CROWN EDGE

TE Internal #: 6643460-1 Board-to-Board, 10 Position, 2.5 mm [.098 in] Centerline, Power & Signal, 2 Power Positions, CROWN EDGE, Card Edge Power Connectors

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Connector System: Board-to-Board

Number of Positions: 10

Centerline (Pitch): 2.5 mm [.098 in]

Contact Current Rating (Max): 35 A

Circuit Application: Power & Signal

Features

Product Type Features

Connector Mates With

Connector & Housing Type

Connector & Contact Terminates To

Printed Circuit Board

Receptacle

Printed Circuit Board

| Connector S | ystem |
|-------------|-------|
|-------------|-------|

Board-to-Board

Configuration Features

| Mating & Unmating Configuration | Hot Pluggable |
|---------------------------------|-----------------------|
| PCB Mount Orientation | Vertical |
| Number of Positions | 10 |
| Number of Power Positions | 2 |
| Number of Signal Positions | 8 |
| Number of Dual Positions | 0 |
| Electrical Characteristics | |
| Operating Voltage | 250 V |
| Body Features | |
| Primary Product Color | Black |
| Contact Features | |
| Signal Contact Plating Material | Select Gold |
| Signal Contact Material | Phosphor Bronze Alloy |

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| Power Contact Base Material | Phosphor Bronze Alloy |
|--|-----------------------------------|
| Power Contact Plating Material | Select Gold |
| | 100 µin |
| Contact Type | Socket |
| Contact Mating Area Plating Material Thickness | .76 μm[30 μin] |
| PCB Contact Termination Area Plating Material Finish | Matte |
| PCB Contact Termination Area Plating Material | Tin |
| Contact Base Material | Phosphor Bronze |
| Contact Current Rating (Max) | 35 A |
| Contact Mating Area Plating Material | Gold |
| Termination Features | |
| Termination Post & Tail Length | 3.56 mm, 4.06 mm[.14 in][.159 in] |
| Termination Method to PCB | Through Hole - Press-Fit |
| Mechanical Attachment | |
| Mating Retention | Without |
| Mating Alignment | With |
| PCB Mount Alignment | Without |
| PCB Mount Retention | Without |
| Connector Mounting Type | Board Mount |
| Housing Features | |
| Housing Material | Thermoplastic |
| Centerline (Pitch) | 2.5 mm[.098 in] |
| Dimensions | |
| Connector Height | 15 mm[.591 in] |
| PCB Thickness (Recommended) | 1.6 mm[.063 in] |
| | .508 in |
| Usage Conditions | |
| Operating Temperature Range | -55 – 105 °C[-67 – 221 °F] |
| Operation/Application | |
| Circuit Application | Power & Signal |
| Industry Standards | |
| UL Flammability Rating | UL 94V-0 |
| | |

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Packaging Features

| Packaging Quantity | 192 |
|---|--|
| Packaging Method | Box |
| Product Compliance For compliance documentation, visit the product page on TE.com> | |
| EU RoHS Directive 2011/65/EU | Compliant |
| EU ELV Directive 2000/53/EC | Compliant |
| China RoHS 2 Directive MIIT Order No 32, 2016 | No Restricted Materials Above Threshold |
| EU REACH Regulation (EC) No. 1907/2006 | Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE 2022 (224) |

Does not contain REACH SVHC

Not Low Halogen - contains Br or Cl > 900 ppm.

Wave solder capable to 265°C

Halogen Content

Solder Process Capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

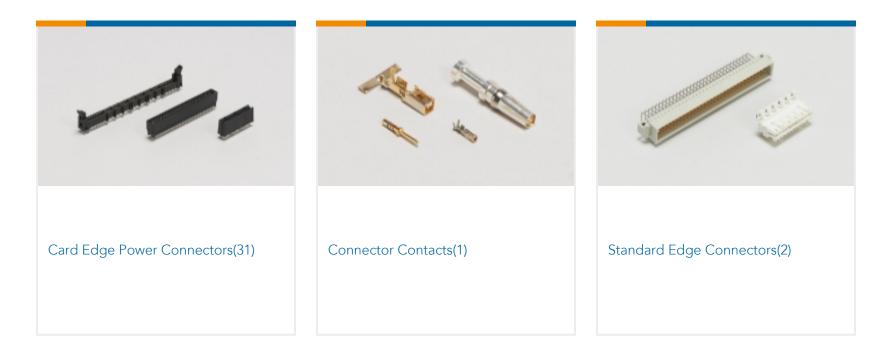


Also in the Series | CROWN EDGE

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Customers Also Bought







Documents

Product Drawings 285-0112-12100=CONN,SKT,SLDR

English

CAD Files

Customer View Model ENG_CVM_CVM_6643460-1_C.2d_dxf.zip

English

3D PDF

3D

Customer View Model ENG_CVM_CVM_6643460-1_C.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_6643460-1_C.3d_stp.zip

English

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Datasheets & Catalog Pages POWER_CONNECTORS_CATALOG_SEC03_CARD_EDGE

English

Product Specifications Application Specification

English